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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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HSDL-4271

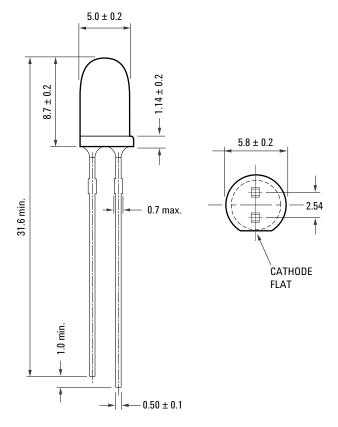
High-Performance T-1¾ (5mm) AlGaAs Infrared (940nm) Lamp



Datasheet

Description

The HSDL-4271 Infrared emitter was designed for applications that require high power and low forward voltage. It utilizes Aluminum Galium Arsenide (AlGaAs) LED technology and is optimized for efficiency at emission wavelengths of 940 nm. The material used produces high radiant efficiency over a wide range of currents. The emitter is packaged in clear T-1¾ (5mm) package.



Features

- High Power AlGaAs LED Technology
- 940 nm Wavelength
- T-1¾ Package
- Low Cost
- Low Forward Voltage: 1.2V at 20mA

Applications

- Industrial Infrared Equipments and Applications (Smoke Detectors etc)
- Consumer Electronics (Infrared Remote Controller etc)
- Infrared spotlight for cameras
- Discrete Interrupters
- Infrared source for optical counters and card readers

Part Number	Lead Form	Shipping Option
HSDL-4271	Straight	Bulk

Absolute Maximum Ratings at 25°C

Parameter	Symbol	Minimum	Maximum	Unit	Reference	
Peak Forward Current	ward Current I _{FPK} - 350		350	mA	Duty cycle = 20% period = 200us	
Forward Current	I _{FDC}	-	100	mA		
Power Dissipation	P _{DISS}	-	200	mW		
Reverse Voltage	V_R	5	-	V	I _R =100uA	
Storage Temperature	Ts	-40	100	°C		
LED Junction Temperature	T _J		110	°C		
Lead Soldering Temperature			260 for 5 sec	°C		

Notes:

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit	Reference
Operating Temperature	T_0	-40	85	°C	

Electrical Characteristics at 25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition	Reference
Forward Voltage	V_{F}	-	1.2 1.4	1.5 1.7	V	I _{FDC} =20mA I _{FDC} =100mA	Figure 2 Figure 3
Forward Voltage Temperature Coefficient	ΔV/ΔΤ	-	-1.0	-	mV/°C	I _{FDC} =100mA	Figure 4
Series Resistance	R _s	-	2	-	Ohms	I _{FDC} =100mA	
Diode Capacitance	Со	-	25	-	pF	V _R =0V, f=1MHz	
Thermal Resistance, Junction to Ambient	$R\theta_{ja}$	-	310	-	°C/W		

Optical Characteristics at 25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	Reference
Radiant On-Axis Intensity	I _E	25	50	-	mW/Sr	I _{LED} =100mA	Figure 4
Radiant On-Axis Intensity Temperature Coefficient	$\Delta I_E/\Delta T$	-	-0.3 -0.5	-	%/°C	I _{LED} =100mA	
Viewing Angle	20 _{1/2}	-	30	-	0		Figure 7
Peak Wavelength	λ_{pk}	-	940	-	nm		Figure 1
Spectral Width	Δλ	-	50	-	nm	I _{LED} =20mA	Figure 1
Optical Rise and Fall Time	t _r /t _f	-	1.3	-	us	I _{LED} =100mA	

^{1.} Derate as shown in Figure 6.

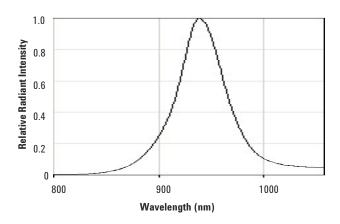


Figure 1. Relative Radiant Intensity vs. Wavelength

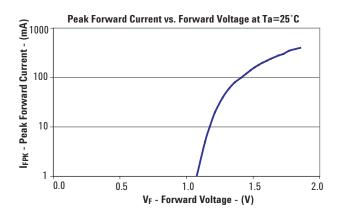


Figure 3. Peak Forward Current vs. Forward Voltage

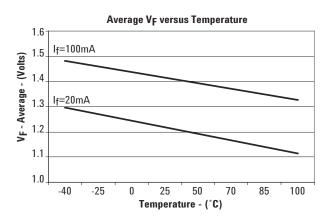


Figure 5. Forward Voltage vs. Ambient Temperature

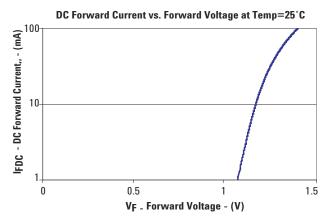


Figure 2. DC Forward Current vs. Forward Voltage

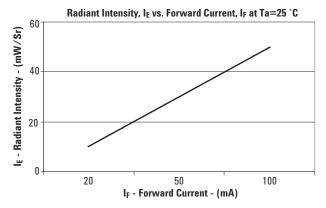


Figure 4. Radiant Intensity vs. DC Forward Current

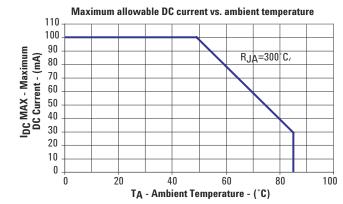


Figure 6: DC Forward Current vs. Ambient Temperature Derated Based on $T_{JMAX}=110^{\circ}C$

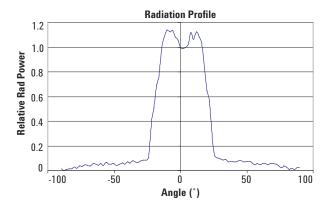


Figure 7. Radiant Intensity vs. Angular Displacement